

## CC2500 and CC2510/CC2511 Sensitivity versus Frequency Offset and Crystal Accuracy

By Sverre Hellan

---

### Keywords

- *Sensitivity*
- *Frequency Offset*
- *Crystal Accuracy*
- *PER (Packet Error Rate)*
- *CC2500*
- *CC2510*
- *CC2511*

### 1 Introduction

This design note provides plots of CC2500 sensitivity versus frequency offset for different data rates. The results are also applicable for CC2510/CC2511.

The required crystal accuracy is calculated from these plots. Throughout this document, CC25xx is used to refer to both CC2500 and CC2510/CC2511.

## Table of Contents

KEYWORDS.....	1
1 INTRODUCTION.....	1
2 ABBREVIATIONS.....	2
3 RECEIVER CHANNEL FILTER BANDWIDTH AND CRYSTAL INACCURACIES .....	3
4 PER VERSUS FREQUENCY OFFSET .....	4
5 CRYSTAL ACCURACY.....	5
APPENDIX A: SENSITIVITY VERSUS FREQUENCY OFFSET .....	6
5.1 2.4 KBAUD.....	6
5.2 10 KBAUD.....	7
5.3 250 KBAUD.....	8
5.4 500 KBAUD.....	9
6 GENERAL INFORMATION .....	10
6.1 DOCUMENT HISTORY.....	10

## 2 Abbreviations

2-FSK	Frequency Shift Keying
IF	Intermediate Frequency
MSK	Minimum Shift Keying
PER	Packet Error Rate
PLL	Phase Locked Loop
ppm	parts per million
SoC	System-on-Chip

## 3 Receiver Channel Filter Bandwidth and Crystal Inaccuracies

A phase locked loop (PLL) is used to generate the RF frequency in the CC2500 transceiver and CC2510/CC2511 SoC. The PLL reference frequency is derived from an external crystal. If the crystal frequency is incorrect, the transmitter carrier frequency and the receiver LO frequency will also be incorrect. The crystal frequency error is due to initial tolerance, capacitive loading errors, ageing, and temperature drift.

### Example 1.

If the crystal frequency has an error of  $\pm X$  ppm (parts per million) the RF frequency also has an error of  $\pm X$  ppm. As an example, if the crystal error is +10 ppm and the CC25xx is programmed for a carrier frequency of 2440 MHz, there will be an error in the carrier frequency of  $2440 \text{ MHz} \cdot 10 / 1 \cdot 10^6 = 24.4 \text{ kHz}$ .

The transmitted signal will have a certain signal bandwidth ( $BW_{\text{signal}}$ ), which depends on the data rate and modulation format. On the receiver side there is a channel filter, which is centered on the down-converted received RF frequency, i.e. the intermediate frequency (IF). The channel filter has a programmable bandwidth  $BW_{\text{channel}}$ . The signal bandwidth has to be less than the receiver channel filter bandwidth, but we also have to take the frequency error of the transmitter and receiver into account.

If there is an error in the transmitter carrier frequency and the receiver LO frequency, there will also be an error in the IF frequency. For simplicity assume the frequency error in the transmitter and receiver is equal (same type of crystal). If the receiver has an error of  $-X$  ppm and the transmitter has an error of  $+X$  ppm the IF frequency will have an error of  $+2 \cdot X$  ppm (CC25xx uses low side LO injection). Conversely, if the receiver has an error of  $+X$  ppm and the transmitter an error of  $-X$  ppm the IF frequency will have an error of  $-2 \cdot X$  ppm.

### Example 2.

If the transmitter crystal error is +10 ppm and the CC2500/10 is programmed for a carrier frequency of 2440 MHz, there will be an error in the carrier frequency of 24.4 kHz. If the receiver crystal error is -10 ppm and the CC25xx is programmed for an LO frequency of 2439.7 MHz (300 kHz IF frequency) there will be an error in the LO frequency of  $-24.397 \text{ kHz}$  (approximately the same as the error in the carrier frequency due to the low IF frequency used). The total error in the IF frequency, after down conversion from RF, will be  $2 \cdot 24.4 \text{ kHz} = 48.8 \text{ kHz}$ .

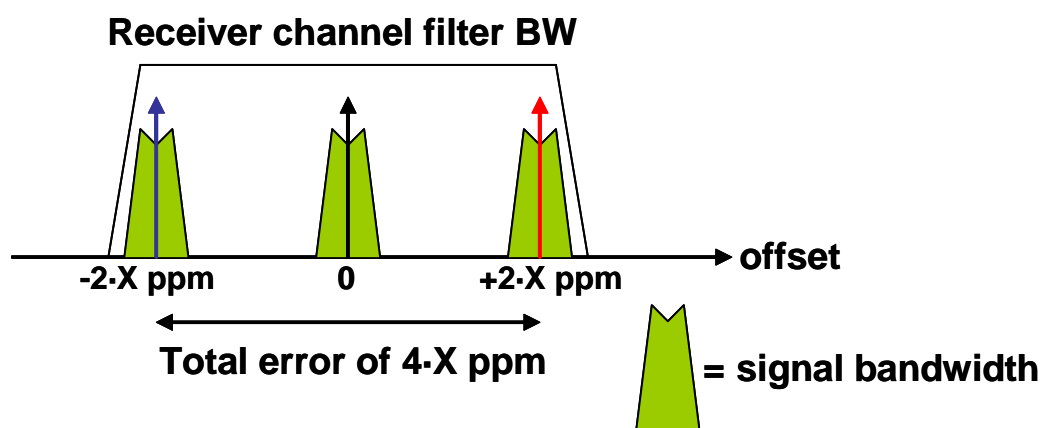


Figure 1. Plot of IF versus Frequency Error

Figure 1 shows the required minimum receiver channel filter bandwidth  $BW_{\text{channel}}$  to account for crystal errors of opposite signs, which is a worst case scenario.  $BW_{\text{channel}}$  has to be larger

than the maximum signal bandwidth  $BW_{\text{signal}}$  plus the maximum frequency error due to crystal inaccuracies.

$$BW_{\text{channel}} > BW_{\text{signal}} + 4 \cdot XTAL_{\text{ppm}} \cdot f_{\text{RF}}$$

where

- $XTAL_{\text{ppm}}$  is the total accuracy of the crystal including initial tolerance, temperature drift, loading, and ageing
- $f_{\text{RF}}$  is the RF operating frequency.

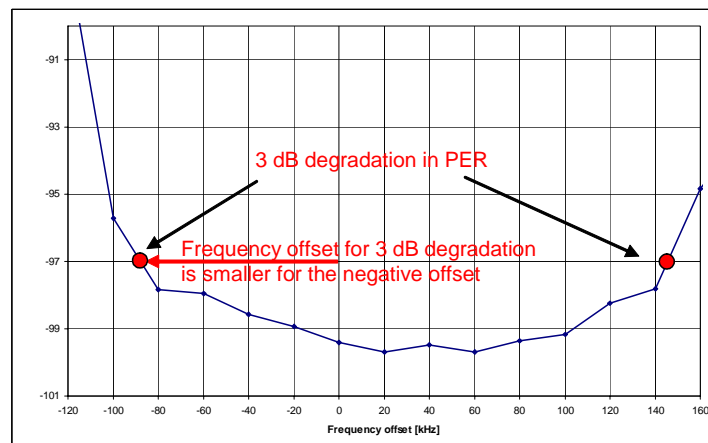
### Example 3.

If both the transmitter and receiver crystal accuracy is  $\pm 10$  ppm and the CC25xx is programmed for a carrier frequency of 2440 MHz with an IF frequency of 300 kHz,  $BW_{\text{channel}}$  must be larger than  $BW_{\text{signal}} + 4 \cdot XTAL_{\text{ppm}} \cdot f_{\text{RF}} = BW_{\text{signal}} + 4 \cdot 24.4 \text{ kHz} = BW_{\text{signal}} + 97.6 \text{ kHz}$ .

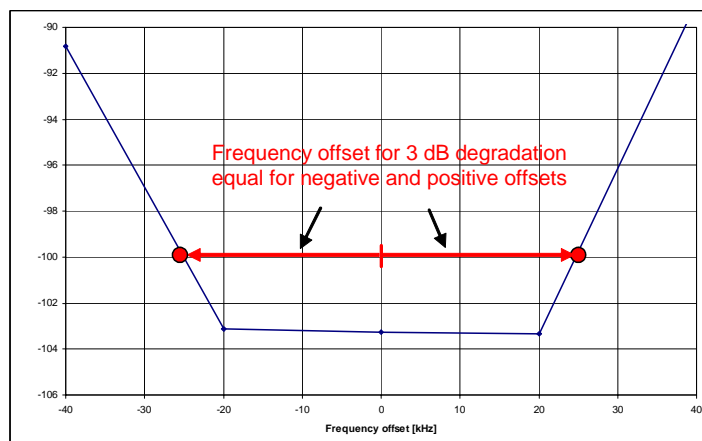
## 4 PER versus Frequency Offset

Figure 4 to Figure 10 plots the 1% PER for different data rates and modulation formats. The RF frequency is 2440 MHz in the measurements. Since the signal bandwidth is given, the plots can be used to estimate the maximum frequency offset and hence the required crystal accuracy.

Assuming a 3 dB loss in sensitivity is acceptable, the *total* frequency offset is estimated as 2 times the frequency offset where a 3 dB degradation in PER is first measured (see Figure 2). In the ideal case the 3 dB degradation in PER should occur at the same positive and negative frequency offsets (see Figure 3). Since the IF frequency is programmed in steps of 25 kHz this is not always possible.



**Figure 2. Definition of Frequency Offset which gives 3 dB Degradation in PER (unsymmetrical frequency offset)**



**Figure 3. Definition of Frequency Offset which gives 3 dB Degradation in PER (symmetrical frequency offset)**

## 5 Crystal Accuracy

Appendix A shows plots of sensitivity versus frequency offset for different data rates. The required crystal accuracy is calculated from the total frequency offset as

$$\text{Total frequency offset} = 4 \cdot \text{XTAL}_{\text{ppm}} \cdot f_{\text{RF}}$$

$$\Rightarrow \text{Crystal accuracy (in ppm)} = \text{Total frequency offset} \cdot 10^6 / (4 \cdot f_{\text{RF}})$$

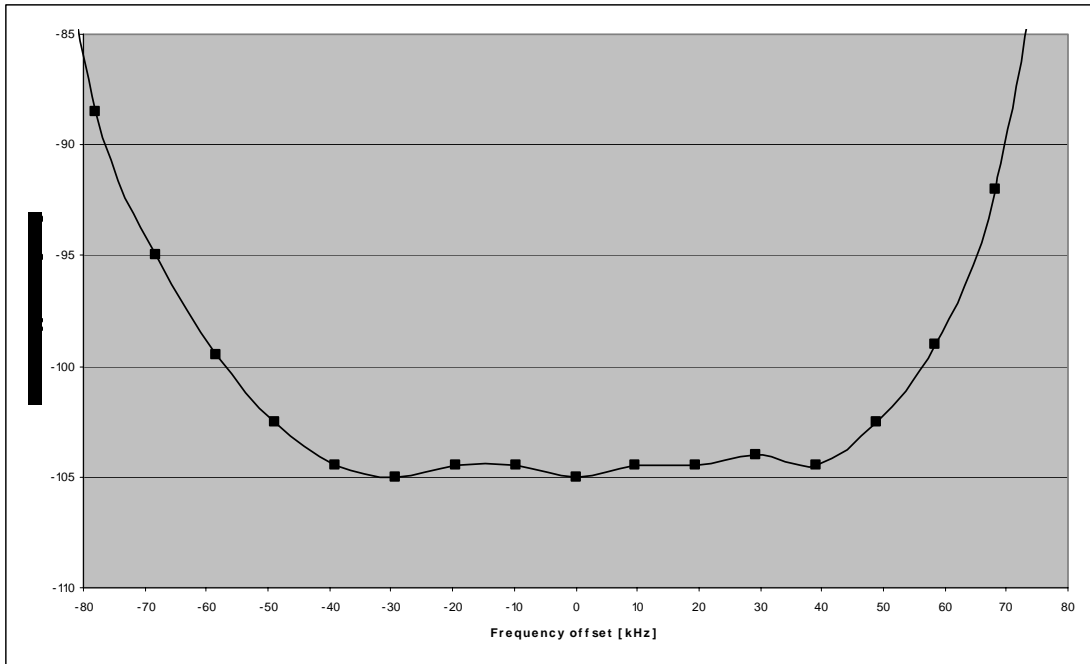
Case	Figure	3 dB Bandwidth (total frequency offset)	Crystal Accuracy (@ 2440 MHz)
2.4 kBaud, 2-FSK, 38 kHz deviation, DC filter. RX filter bandwidth = 203 kHz.	Figure 4	100 kHz	±10 ppm
2.4 kBaud, 2-FSK, 38 kHz deviation, no DC filter. RX filter bandwidth = 203 kHz.	Figure 5	100 kHz	±10 ppm
10 kBaud, 2-FSK, 38 kHz deviation, DC filter. RX filter bandwidth = 232 kHz.	Figure 6	130 kHz	±13 ppm
10 kBaud, 2-FSK, 38 kHz deviation, no DC filter. RX filter bandwidth = 232 kHz.	Figure 7	150 kHz	±15 ppm
250 kBaud, MSK, DC filter. RX filter bandwidth = 541 kHz.	Figure 8	140 kHz	±14 ppm
250 kBaud, MSK, no DC filter. RX filter bandwidth = 541 kHz.	Figure 9	140 kHz	±14 ppm
500 kBaud, MSK, DC filter. RX filter bandwidth = 812 kHz.	Figure 10	200 kHz	±20 ppm

**Table 1. Crystal Accuracy Requirement for Selected Data Rates and Modulation Formats**

Note: The ADC spectrum in the RX chain consists of a significant DC component. This puts a lower limit on the IF frequency that can be used. For optimum sensitivity, a digital DC filter can be enabled (MDMCFG2.DEM\_DCFILT\_OFF=0), and the ADC DC output is attenuated. This opens for selection of a lower IF frequency and thereby lower noise floor and improved sensitivity. As an example, for 2440 MHz, 250 kBaud MSK, enabling the DC filter gives 2 dB better sensitivity at the expense of an increased current consumption of 2.2 mA.

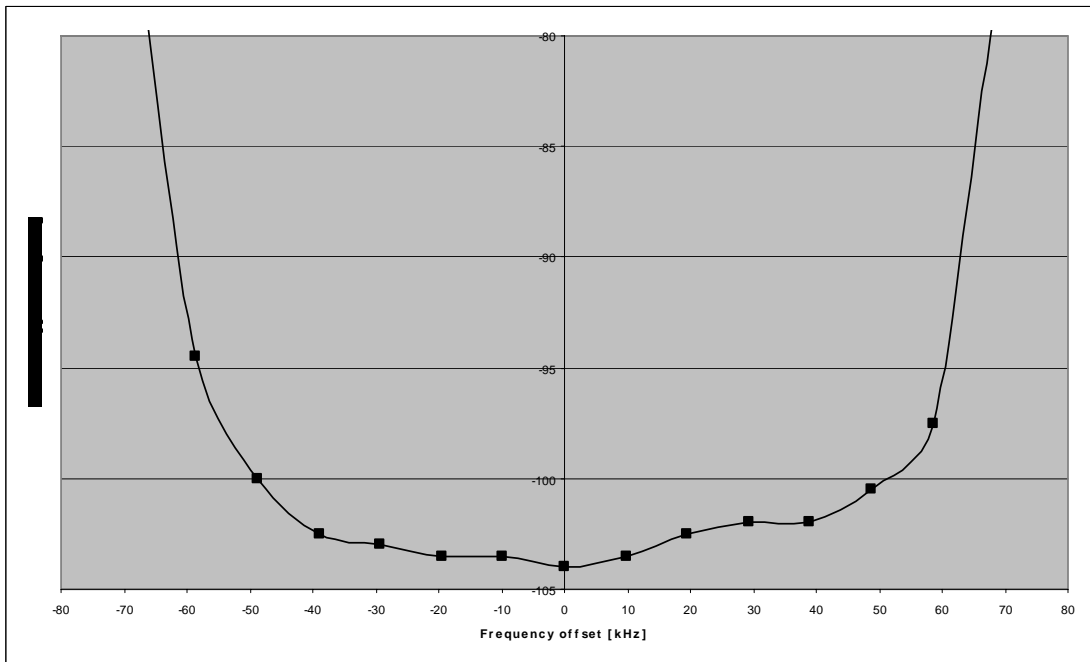
## Appendix A: Sensitivity versus Frequency Offset

### 5.1 2.4 kBaud



FOCCFG.FOC_LIMIT[1:0]	10 <sub>b</sub>
FCTRL1	0x08

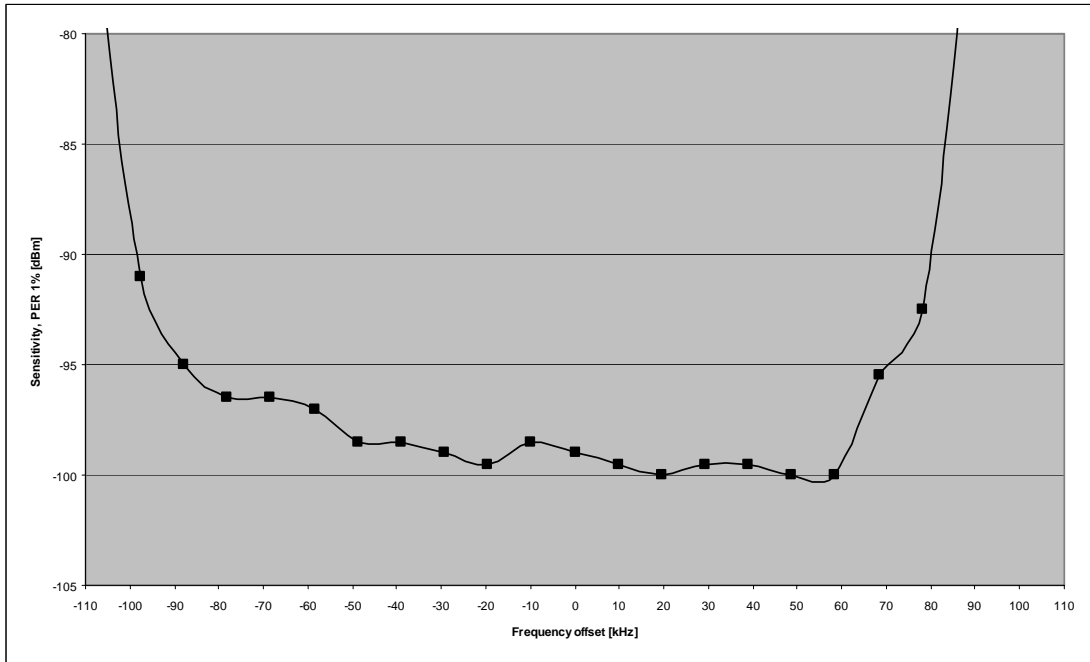
Figure 4. 2.4 kBaud, MDMCFG2.DEM\_DCFLT\_OFF = 0



FOCCFG.FOC_LIMIT[1:0]	11 <sub>b</sub>
FCTRL1	0x0B

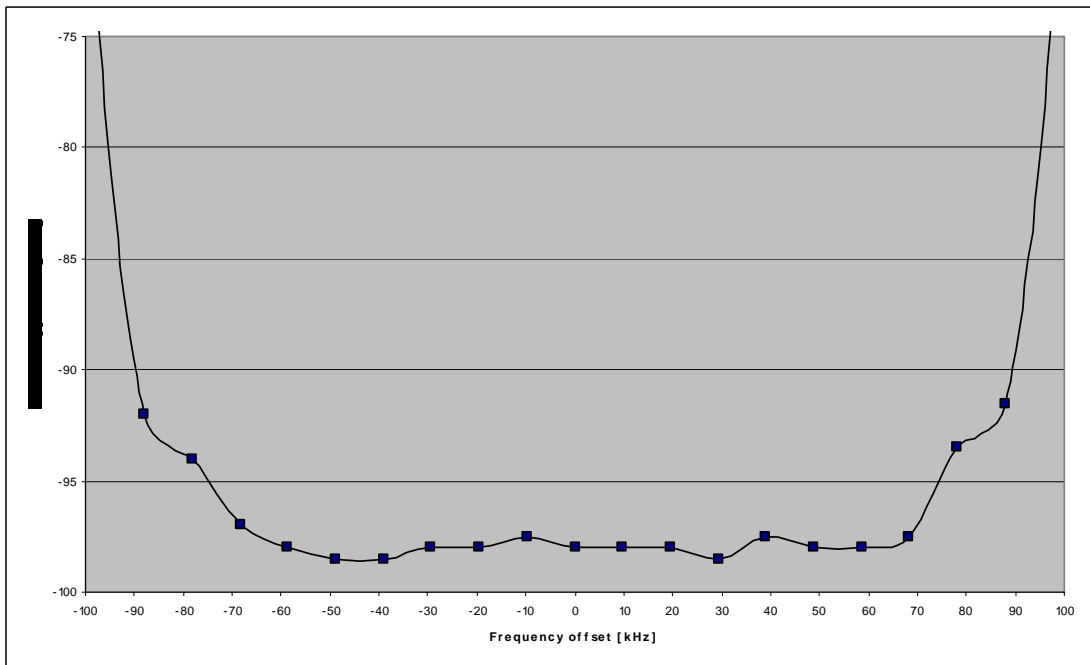
Figure 5. 2.4 kBaud, MDMCFG2.DEM\_DCFLT\_OFF = 1

## 5.2 10 kBaud



FOCCFG.FOC_LIMIT[1:0]	10 <sub>b</sub>
FSCTRL1	0x06

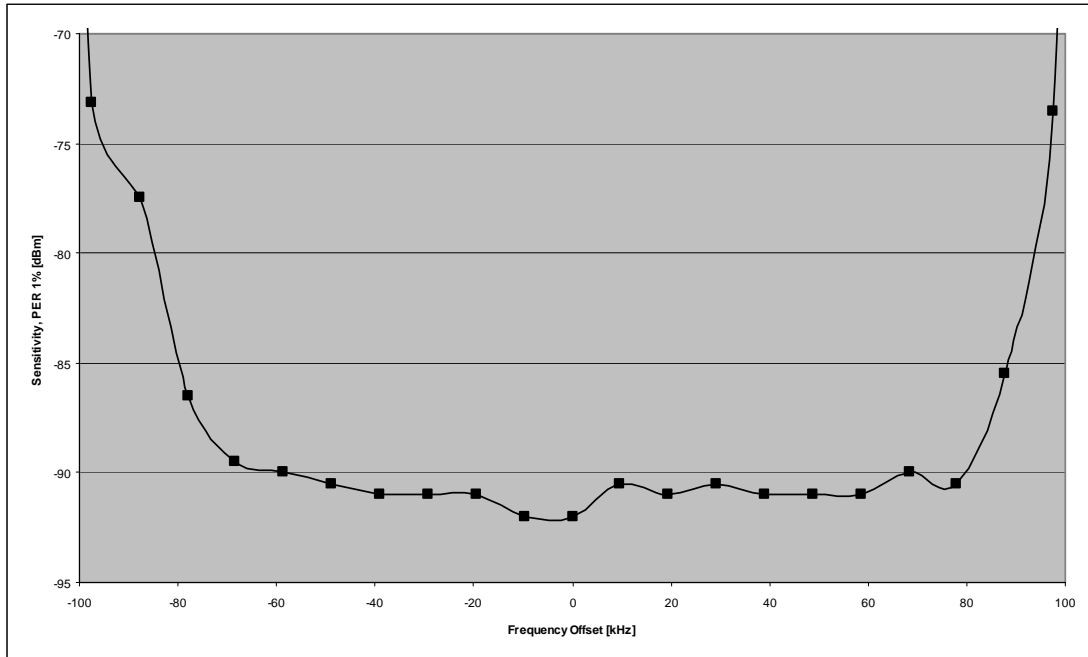
Figure 6. 10 kBaud, MDMCFG2.DEM\_DCFILT\_OFF = 0



FOCCFG.FOC_LIMIT[1:0]	10 <sub>b</sub>
FSCTRL1	0x0B

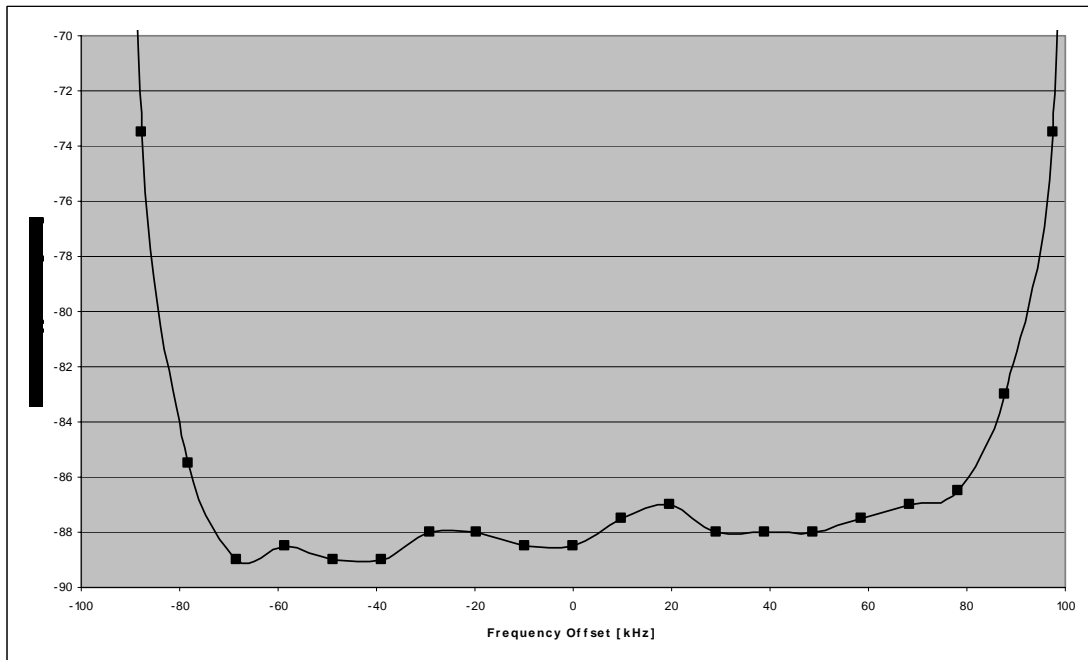
Figure 7. 10 kBaud, MDMCFG2.DEM\_DCFILT\_OFF = 1

## 5.3 250 kBaud



FOCCFG.FOC_LIMIT[1:0]	01 <sub>b</sub>
FSCtrl1	0x0A

Figure 8. 250 kBaud, MDMCFG2.DEM\_DCFILT\_OFF = 0

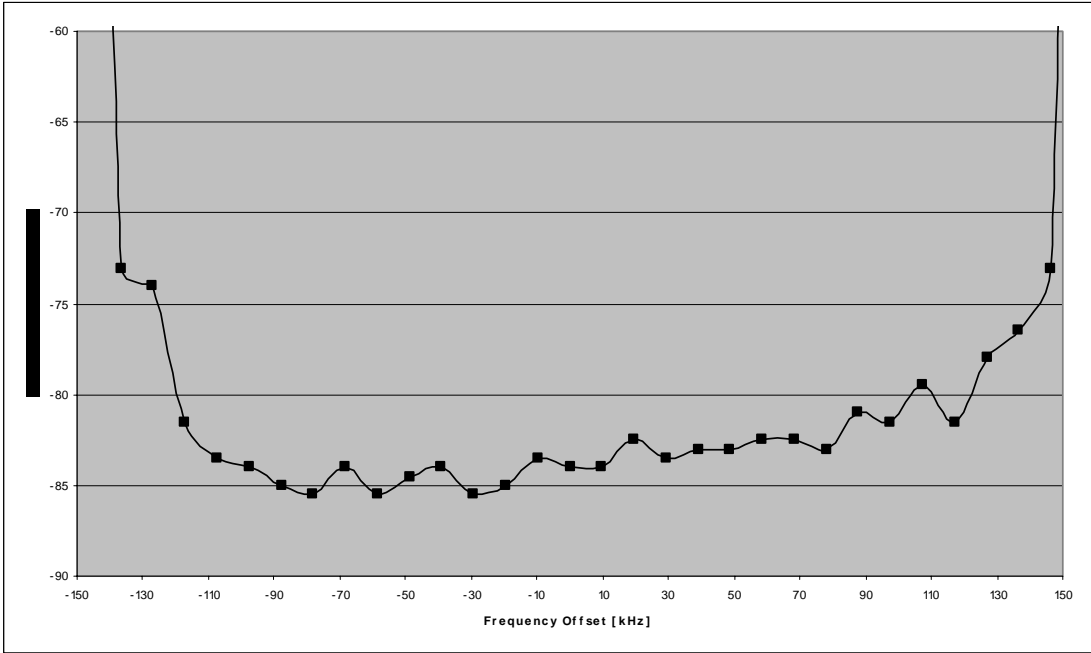


FOCCFG.FOC_LIMIT[1:0]	01 <sub>b</sub>
FSCtrl1	0x12

Figure 9. 250 kBaud, MDMCFG2.DEM\_DCFILT\_OFF = 1



5.4 500 kBaud



FOCCFG.FOC_LIMIT[1:0]	01 <sub>b</sub>
FCTRL1	0x10

Figure 10. 500 kBaud, MDMCFG2.DEM\_DECFILT\_OFF = 0

# *Design Note DN021*

## 6 General Information

### 6.1 Document History

Revision	Date	Description/Changes
SWRA181	2008-03-10	Initial release

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>

### Applications

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2008, Texas Instruments Incorporated